ABSOCIATION CONNECTING ELECTROMICS INDUSTRIES INCOMPACTING OF CONVICTING	Bannockb	urn. Illinois. A	ll rights reserved un tions.	nder both	This docume level parts, t	ent is a declarati the declaration e	on of the sub ncompasses a	stances v all lower	within the manufactur level materials for wl	er listed i hich the 1	item. Note: if nanufacturer	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				als and Mfg Information					
Supplier Information														
Company name* Comp			Company unique ID			Unique ID Authority					Response Date*			
nsemi									2024-05-05					
Contact Name	ame Title - Contact				Phone - Contact*				Email - Contact*					
roduct-Env-Stewards Product Enviro			viro Compliance		NA			Product-Env-Stewards@onsemi.com						
Authorized Representative* Title - Repres			sentative		Phone - Representative*			Email - Representative*						
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		umber Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	AMIS427	AMIS42770ICAW1G HS CAN RE		EATER		2024-05-05		PI	PHG		612.57	mg	Each	
Manufacturing Proccess Information	on													
Terminal Plating / Grid Array Mate	/ Grid Array Material Terminal Base Alloy		Alloy J	J-STD-020 MSL Rating		Peak Process Body Temperature Max Tir		e Max Time at Peak	ak Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed CU Alloy		2	2		260	0	С	30	seco	nds 3				
Comments														
ATTENTION: MSL 2 Rated item requires l	Dry Pack (a	fter electrical	test)											
For more information regarding material co	mposition j	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	35.93	mg	Supplier	Silicon (Si)	7440-21-3		35.93	mg	
Die Attach	6.55	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		1.5065	mg	
			Supplier	Silver (Ag)	7440-22-4		5.0435	mg	
Lead Frame	188.57	mg	Supplier	Zinc (Zn)	7440-66-6		0.1886	mg	
			Supplier	Iron (Fe)	7439-89-6		4.3371	mg	
			Supplier	Copper (Cu)	7440-50-8		183.8558	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.1886	mg	
Mold Compound-Black	377.0	mg		Epoxy Phenol Resin	proprietary data		39.585	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		337.415	mg	
Plating	3.7	mg	Supplier	Tin (Sn)	7440-31-5		3.7	mg	
Wire Bond - Au	0.82	mg	Supplier	Gold (Au)	7440-57-5		0.82	mg	